



# N-Channel Enhancement-Mode Vertical DMOS FETs

## Features

- ▶ Free from secondary breakdown
- ▶ Low power drive requirement
- ▶ Ease of paralleling
- ▶ Low  $C_{ISS}$  and fast switching speeds
- ▶ Excellent thermal stability
- ▶ Integral source-drain diode
- ▶ High input impedance and high gain

## Applications

- ▶ Motor controls
- ▶ Converters
- ▶ Amplifiers
- ▶ Switches
- ▶ Power supply circuits
- ▶ Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

## Ordering Information

Part Number	Package Option	Packing
VN3205N3-G	3-Lead TO-92	1000/Bag
VN3205N3-G P002	3-Lead TO-92	2000/Reel
VN3205N3-G P003		
VN3205N3-G P005		
VN3205N3-G P013		
VN3205N3-G P014		
VN3205N8-G	3-Lead TO-243AA (SOT-89)	2000/Reel
VN3205NW	Die in wafer form	---
VN3205NJ	Die on adhesive tape	---
VN3205ND	Die in waffle pack	---

For packaged products, -G indicates package is RoHS compliant ('Green').  
 TO-92 taping specifications and winding styles per EIA-468 Standard.  
 Devices in Wafer / Die form are RoHS compliant ('Green').  
 Refer to Die Specification VF32 for layout and dimensions.

## Absolute Maximum Ratings

Parameter	Value
Drain-to-source voltage	$BV_{DSS}$
Drain-to-gate voltage	$BV_{DGS}$
Gate-to-source voltage	$\pm 20V$
Operating and storage temperature	$-55^{\circ}C$ to $+150^{\circ}C$

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

## Typical Thermal Resistance

Package	$\theta_{ja}$
3-Lead TO-92	132°C/W
3-Lead TO-243AA (SOT-89)	133°C/W

## General Description

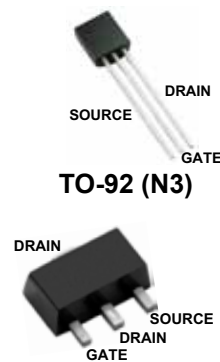
This enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

## Product Summary

$BV_{DSS}/BV_{DGS}$ (V)	$R_{DS(ON)}$ (max) ( $\Omega$ )	$V_{GS(th)}$ (max) (V)
50	0.3	2.4

## Pin Configuration



TO-243AA (SOT-89) (N8)

## Product Marking



YY = Year Sealed  
 WW = Week Sealed  
 \_\_\_\_\_ = "Green" Packaging

Package may or may not include the following marks: Si or

TO-92 (N3)



W = Code for week sealed  
 \_\_\_\_\_ = "Green" Packaging

Package may or may not include the following marks: Si or

TO-243AA (SOT-89) (N8)

## Thermal Characteristics

Package	$I_D$ (continuous)* (A)	$I_D$ (pulsed) (A)	Power Dissipation @ $T_c = 25^\circ\text{C}$ (W)	$I_{DR}^\dagger$ (A)	$I_{DRM}$ (A)
TO-92	1.2	8.0	1.0	1.2	8.0
TO-243AA	1.5	8.0	1.6 ( $T_A = 25^\circ$ )	1.5	8.0

### Notes:

\*  $I_D$  (continuous) is limited by max rated  $T_f$ ,  $T_a = 25^\circ\text{C}$ .

† Total for package.

‡ Mounted on FR5 board, 25mm x 25mm x 1.57mm.

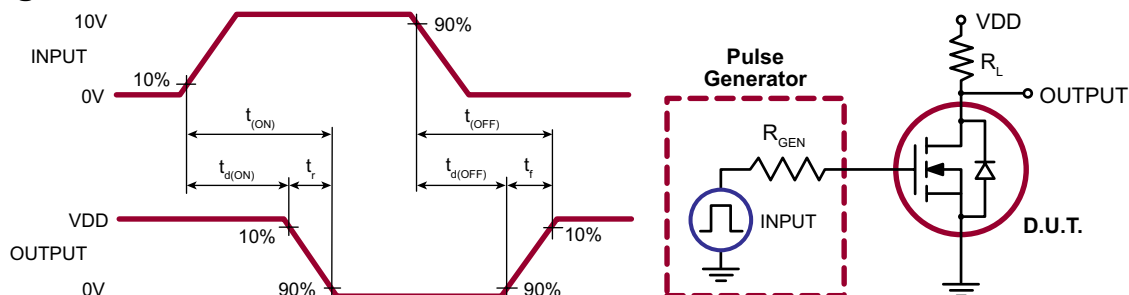
## Electrical Characteristics ( $T_J = 25^\circ\text{C}$ unless otherwise specified)

Sym	Parameter	Min	Typ	Max	Units	Conditions	
$BV_{DSS}$	Drain-to-Source breakdown voltage	50	-	-	V	$V_{GS} = 0V, I_D = 10mA$	
$V_{GS(th)}$	Gate threshold voltage	0.8	-	2.4	V	$V_{GS} = V_{DS}, I_D = 10mA$	
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with temperature	-	-4.3	-5.5	mV/°C	$V_{GS} = V_{DS}, I_D = 10mA$	
$I_{GSS}$	Gate body leakage current	-	1.0	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
$I_{DSS}$	Zero Gate voltage drain current	-	-	10	$\mu A$	$V_{GS} = 0V, V_{DS} = \text{Max Rating}$	
		-	-	1.0	mA	$V_{DS} = 0.8 \text{ Max Rating}, V_{GS} = 0V, T_A = 125^\circ\text{C}$	
$I_{D(ON)}$	ON-state Drain current	3.0	14	-	A	$V_{GS} = 10V, V_{DS} = 5.0V$	
$R_{DS(ON)}$	Static Drain-to-Source ON-state resistance	TO-92	-	-	0.45	$\Omega$	$V_{GS} = 4.5V, I_D = 1.5A$
		TO-243AA	-	-	0.45		$V_{GS} = 4.5V, I_D = 0.75A$
		TO-92	-	-	0.3		$V_{GS} = 10V, I_D = 3.0A$
		TO-243AA	-	-	0.3		$V_{GS} = 10V, I_D = 1.5A$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with temperature	-	0.85	1.2	%/°C	$V_{GS} = 10V, I_D = 3.0A$	
$G_{FS}$	Forward transconductance	1.0	1.5	-	mho	$V_{DS} = 25V, I_D = 2.0A$	
$C_{ISS}$	Input capacitance	-	220	300	pF	$V_{GS} = 0V,$ $V_{DS} = 25V,$ $f = 1.0MHz$	
$C_{OSS}$	Common Source output capacitance	-	70	120			
$C_{RSS}$	Reverse transfer capacitance	-	20	30			
$t_{d(ON)}$	Turn-on delay time	-	-	10	ns	$V_{DD} = 25V,$ $I_D = 2.0A,$ $R_{GEN} = 10\Omega$	
$t_r$	Rise time	-	-	15			
$t_{d(OFF)}$	Turn-off delay time	-	-	25			
$t_f$	Fall time	-	-	25			
$V_{SD}$	Diode forward voltage drop	-	-	1.6	V	$V_{GS} = 0V, I_{SD} = 1.5A$	
$t_{rr}$	Reverse recovery time	-	300	-	ns	$V_{GS} = 0V, I_{SD} = 1.0A$	

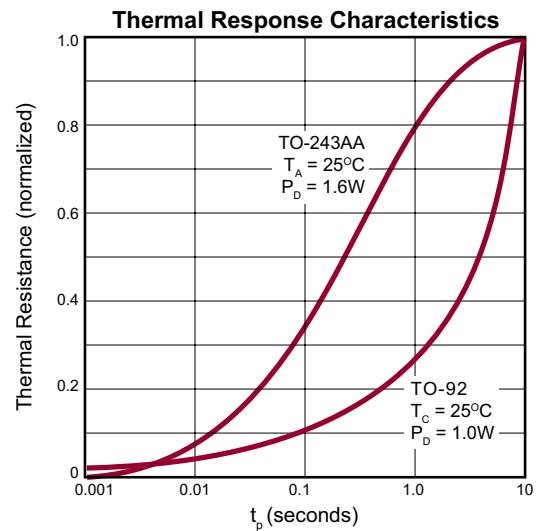
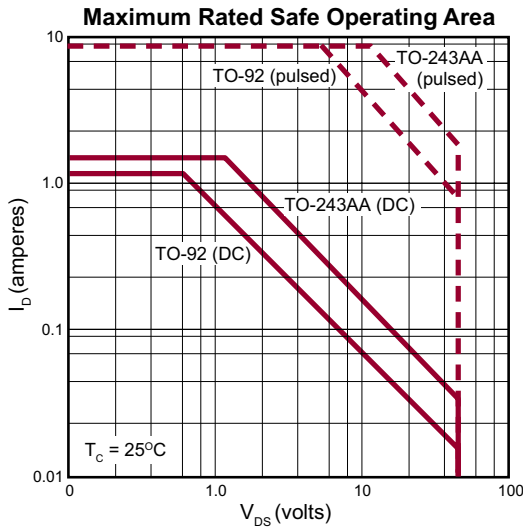
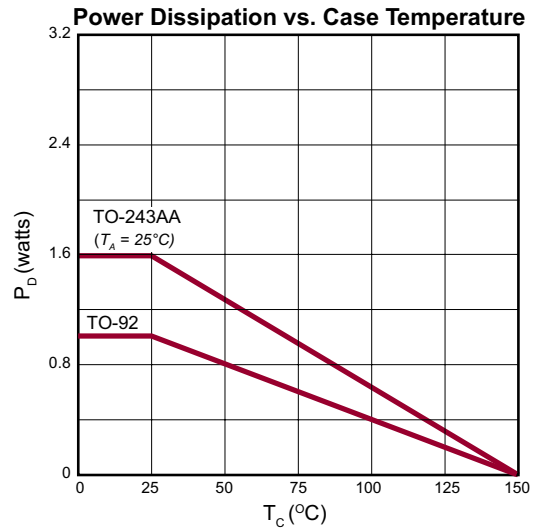
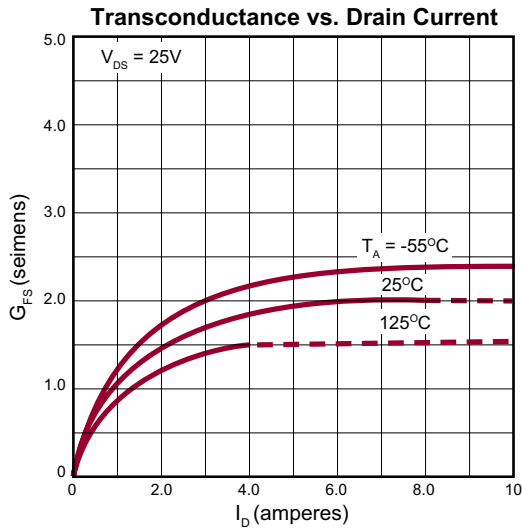
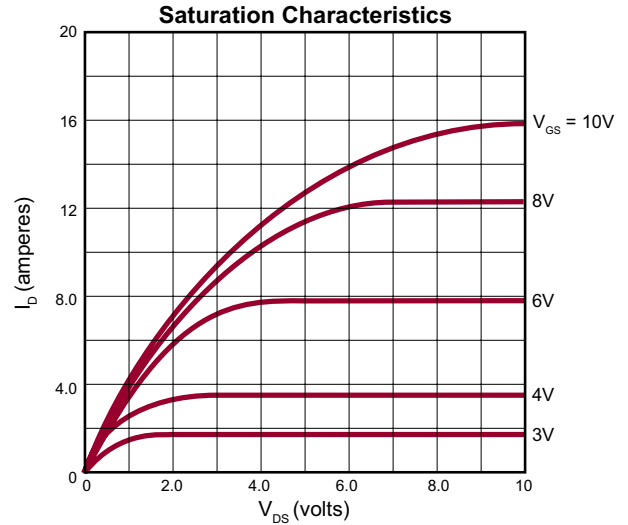
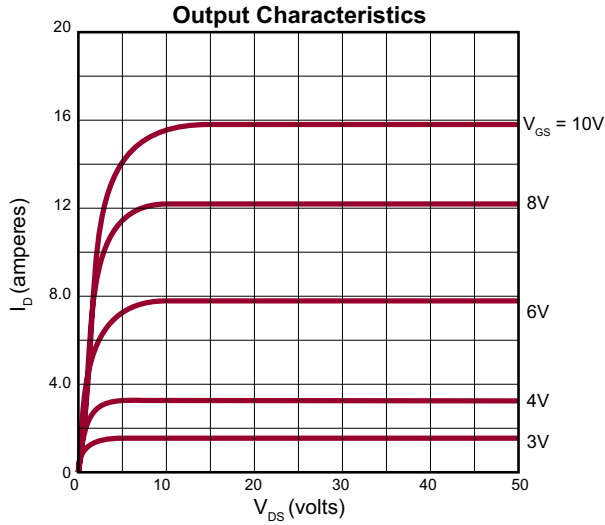
### Notes:

- All D.C. parameters 100% tested at  $25^\circ\text{C}$  unless otherwise stated. (Pulse test: 300 $\mu s$  pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

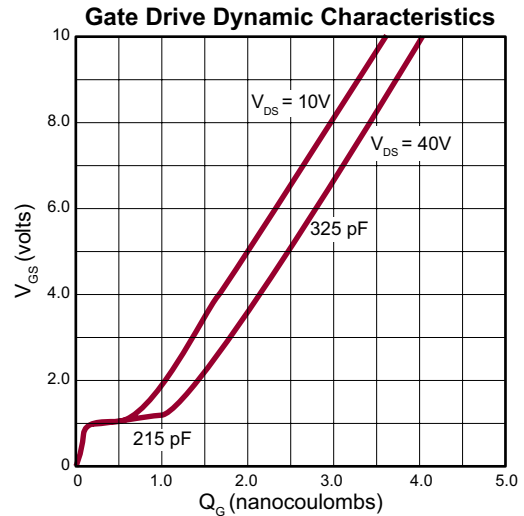
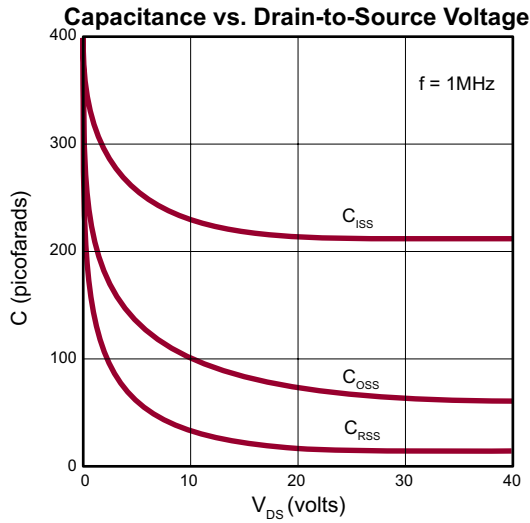
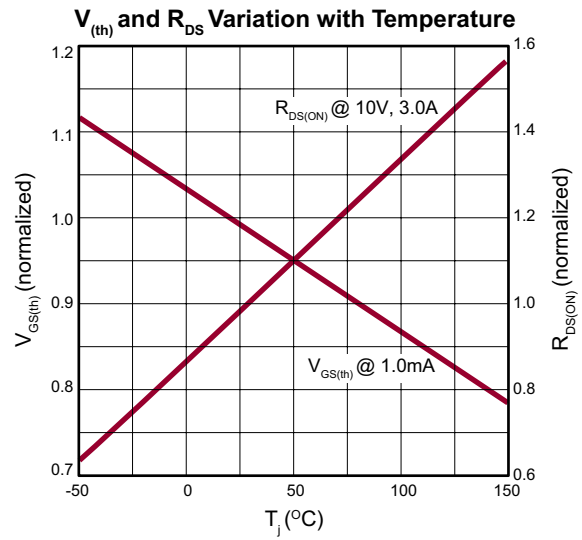
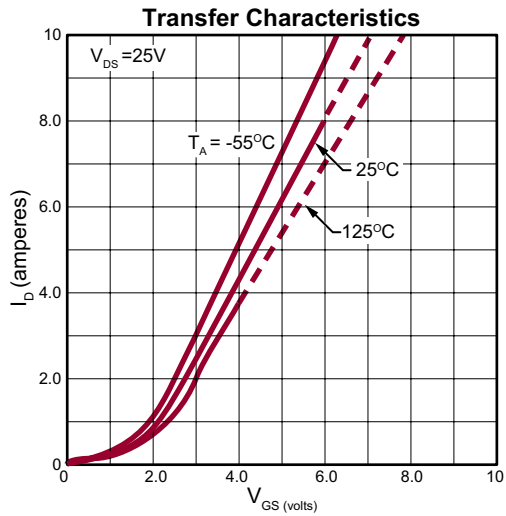
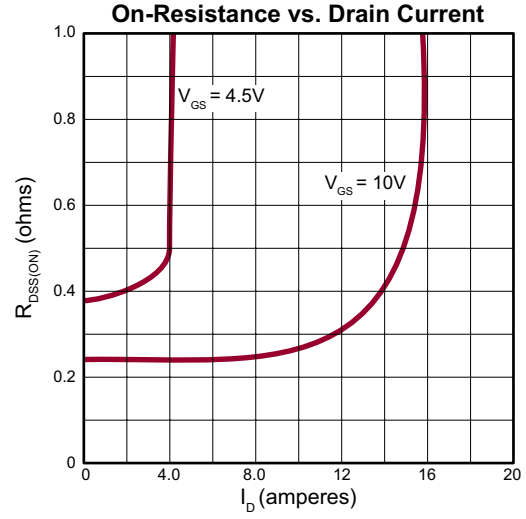
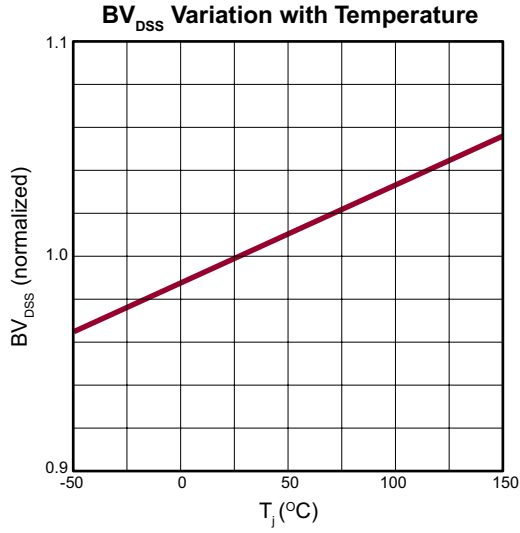
## Switching Waveforms and Test Circuit



# Typical Performance Curves



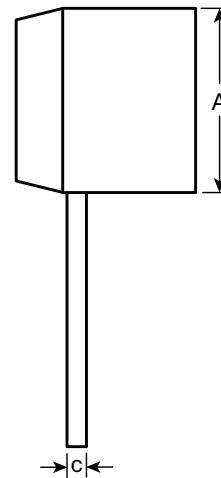
Typical Performance Curves (cont.)



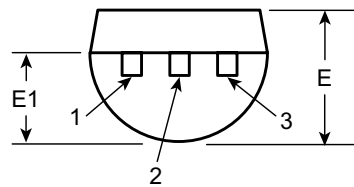
### 3-Lead TO-92 Package Outline (N3)



**Front View**



**Side View**



**Bottom View**

Symbol		A	b	c	D	E	E1	e	e1	L
Dimensions (inches)	MIN	.170	.014 <sup>†</sup>	.014 <sup>†</sup>	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022 <sup>†</sup>	.022 <sup>†</sup>	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

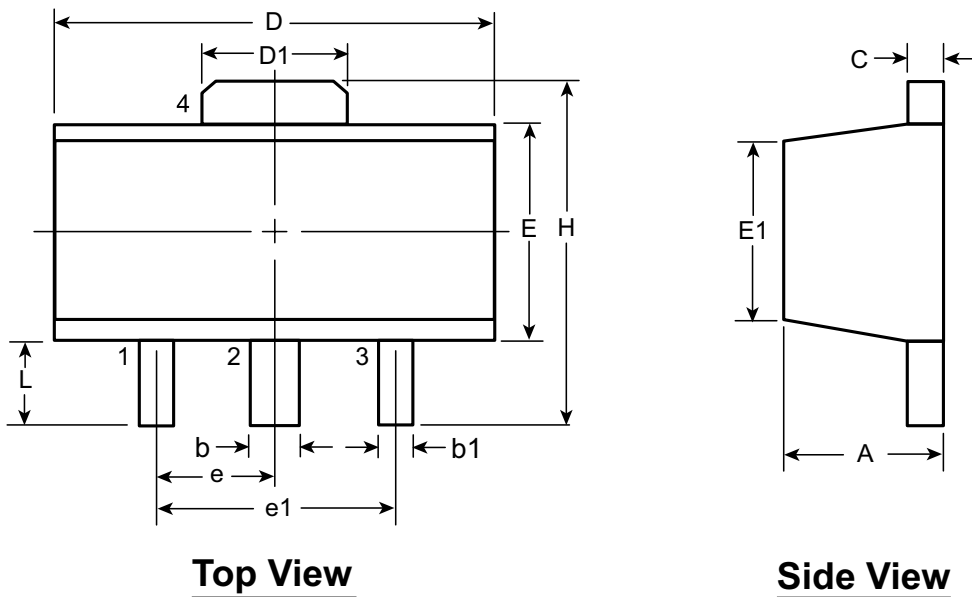
\* This dimension is not specified in the JEDEC drawing.

† This dimension differs from the JEDEC drawing.

**Drawings not to scale.**

**Supertex Doc.#:** DSPD-3TO92N3, Version E041009.

### 3-Lead TO-243AA (SOT-89) Package Outline (N8)



Symbol		A	b	b1	C	D	D1	E	E1	e	e1	H	L
Dimensions (mm)	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.00 <sup>†</sup>	1.50 BSC	3.00 BSC	3.94	0.73 <sup>†</sup>
	NOM	-	-	-	-	-	-	-	-			-	-
	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29			4.25	1.20

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.

<sup>†</sup> This dimension differs from the JEDEC drawing

**Drawings not to scale.**

**Supertex Doc. #: DSPD-3TO243AAN8, Version F111010.**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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#### Как с нами связаться

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